

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3172721

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	BO-SHIH HUANG	02/22/2013
	TSUNG-MING CHEN	02/22/2013
	YUAN-HUNG CHUNG	02/22/2013
RECEIVING PARTY DATA		
Name:	MEDIATEK INC	
Street Address:	NO. 1, DUSING RD. 1ST., SCIENCE-BASED INDUSTRIAL PARK	
City:	HSIN-CHU	
State/Country:	TAIWAN	
Postal Code:	300	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14591254	
CORRESPONDENCE DATA		
Fax Number:	(404)521-4286	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	678-483-8899	
Email:	dan.mcclure@mqlaw.com	
Correspondent Name:	MCCLURE, QUALEY & RODACK, LLP	
Address Line 1:	3100 INTERSTATE NORTH CIRCLE	
Address Line 2:	SUITE 150	
Address Line 4:	ATLANTA, GEORGIA 30339	
ATTORNEY DOCKET NUMBER:	251325-4031	
NAME OF SUBMITTER:	DANIEL R. MCCLURE	
SIGNATURE:	/Daniel R. McClure/	
DATE SIGNED:	01/07/2015	
Total Attachments: 1		
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ASSIGNMENT

WHEREAS, Bo-Shih HUANG, Tsung-Ming CHEN, and Yuan-Hung CHUNG

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: ESD PROTECTION CIRCUIT

Filed: OCT. 29, 2012

Serial No. 13/662,851

Executed on: _____

WHEREAS, MediaTek Inc. of No. 1, Dusing Rd. 1st, Science-Based Industrial Park, Hsin-Chu 300, Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Bo-Shih Huang
Bo-Shih HUANG

2013.2.22
Date

Tsung-Ming Chen
Tsung-Ming CHEN

2013.2.22
Date

Yuan-Hung Chung
Yuan-Hung CHUNG

2013.2.22
Date